

1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任 何异议请及时告之,我们将妥善解决。

本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。

3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。

4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

Read Statement

1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.

2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.

3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.

4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets".



TMBYV 10-40

SMALL SIGNAL SCHOTTKY DIODES



DESCRIPTION

Metal to silicon rectifier diodes in glass case featuring very low forward voltage drop and fast recovery time, intended for low voltage switching mode power supply, polarity protection and high frequency circuits.

Symbol **Parameter** Value Unit Repetitive Peak Reverse Voltage 40 V V_{RRM} Average Forward Current $T_i = 60 \ ^{\circ}C$ А 1 I_{F (AV)} Surge non Repetitive Forward Current $T_i = 25 \ ^{\circ}C$ 25 А I_{FSM} Sinusoïdal Pulse $t_p = 10ms$ $T_i = 25 \ ^{\circ}C$ 50 **Rectangular Pulse** $t_{p} = 300 \mu s$ T_{stg} Tj Storage and Junction Temperature - 65 to 150 °C - 65 to 125 °C Range Maximum Lead Temperature for Soldering during 15s 260 °C ΤL

ABSOLUTE MAXIMUM RATINGS (limiting values)

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit			
R _{th (j} - I)	Junction-leads	110	°C/W			
* Dulco toot: $t < 200 \text{uc}$ S < 2%						

* Pulse test: $t_p \le 300 \mu s \ \delta < 2\%$.

August 1999 Ed: 1A

TMBYV10-40

ELECTRICAL CHARACTERISTICS STATIC CHARACTERISTICS

Synbol	Test Conditions			Тур.	Max.	Unit
۱ _R *	$T_j = 25^{\circ}C$	$V_{R} = V_{RRM}$			0.5	mΔ
	T _j = 100°C				10	
V _F *	IF = 1A	$T_j = 25^{\circ}C$			0.55	V
	IF = 3A				0.85	

* * Pulse test: $t_p \leq 300 \mu s \ \delta < 2\%$.

DYNAMIC CHARACTERISTICS

Symbol	Test Conditions			Тур.	Max.	Unit
С	$T_j = 25^{\circ}C$	$V_R = 0$		220		pF

Forward current flow in a Schottky rectifier is due to majority carrier conduction. So reverse recovery is not affected by storage charge as in conventional PN junction diodes.

Nevertheless, when the device switches from forward biased condition to reverse blocking state, current is required to charge the depletion capacitance of the diode.

Fig. 1: Forward current versus forward voltage at low level (typical values).



tion capacitance (see fig. 5 page 4/4).

This current depends only of diode capacitance and

external circuit impedance. Satisfactory circuit be-

haviour analysis may be performed assuming that

Schottky rectifier consists of an ideal diode in parallel with a variable capacitance equal to the junc-

Fig. 2: Forward current versus forward voltage at high level (typical values).



<u>ل</u>حک

2/4

Fig. 3 : Reverse current versus junction temperature.



Fig. 5 : Capacitance C versus reverse applied voltage V_{R} (typical values)



Fig. 4 : Reverse current versus VRRM in per cent.



Fig. 6 : Surge non repetitive forward current for a rectangular pulse with t \hat{a} 10 ms.



TMBYV10-40

Fig. 7: Surge non repetitive forward current versus number of cycles.





PACKAGE MECHANICAL DATA **MELF Glass**





FOOT PRINT DIMENSIONS (Millimeter)



REF.	DIMENSIONS					
	Millimeters			Millimeters Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.80		5.20	0.189		0.205
ØB	2.50		2.65	0.098		0.104
С	0.45		0.60	0.018		0.024
ØD		2.50			0.098	

Cooling method: by convection and conduction Marking: ring at cathode end. Weight: 0.139g

ORDERING CODE : TMBYV10-40 FILM

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied.

STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

© 1999 STMicroelectronics - Printed in Italy - All rights reserved.

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - China - Finland - France - Germany - Hong Kong - India - Italy - Japan - Malaysia Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - U.S.A.

http://www.st.com

<u>ل</u>حک